

NJL1302D Datasheet



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DiGi Electronics Part Number NJL1302D-DG

Manufacturer onsemi

Manufacturer Product Number NJL1302D

Description TRANS PNP 260V 15A TO264

Detailed Description Bipolar (BJT) Transistor PNP 260 V 15 A 30MHz 200

W Through Hole TO-264



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Purchase and inquiry

| Manus factorium Durado et Novembrano | Manufacturer |
|--|--|
| Manufacturer Product Number: | Manufacturer: |
| NJL1302D | onsemi |
| Series: | Product Status: |
| | Obsolete |
| Transistor Type: | Current - Collector (Ic) (Max): |
| PNP | 15 A |
| Voltage - Collector Emitter Breakdown (Max): | Vce Saturation (Max) @ lb, Ic: |
| 260 V | 3V @ 1A, 10A |
| Current - Collector Cutoff (Max): | DC Current Gain (hFE) (Min) @ Ic, Vce: |
| 50μA (ICBO) | 75 @ 5A, 5V |
| Power - Max: | Frequency - Transition: |
| 200 W | 30MHz |
| Operating Temperature: | Mounting Type: |
| -65°C ~ 150°C (TJ) | Through Hole |
| Package / Case: | Supplier Device Package: |
| TO-264-5 | TO-264 |
| Base Product Number: | |
| NJL1302 | |

Environmental & Export classification

| RoHS Status: | Moisture Sensitivity Level (MSL): |
|--------------------|-----------------------------------|
| RoHS non-compliant | 1 (Unlimited) |
| REACH Status: | ECCN: |
| REACH Unaffected | EAR99 |
| HTSUS: | |
| 8541.29.0075 | |

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Complementary ThermalTrak™ Transistors

The ThermalTrak family of devices has been designed to eliminate thermal equilibrium lag time and bias trimming in audio amplifier applications. They can also be used in other applications as transistor die protection devices.

Features

- Thermally Matched Bias Diode
- Instant Thermal Bias Tracking
- Absolute Thermal Integrity
- High Safe Operating Area
- Pb-Free Packages are Available*

Benefits

- Eliminates Thermal Equilibrium Lag Time and Bias Trimming
- Superior Sound Quality Through Improved Dynamic Temperature Response
- Significantly Improved Bias Stability
- Simplified Assembly
 - Reduced Labor Costs
 - Reduced Component Count
- High Reliability

Applications

- High-End Consumer Audio Products
 - Home Amplifiers
 - Home Receivers
- Professional Audio Amplifiers
 - Theater and Stadium Sound Systems
 - Public Address Systems (PAs)



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BIPOLAR POWER TRANSISTORS 15 AMP, 260 VOLT, 200 WATT

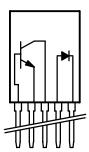


TO-264, 5 LEAD CASE 340AA STYLE 1

MARKING DIAGRAM

SCHEMATIC





NJLxxxxD = Device Code

xxxx = 3281 or 1302

G = Pb-Free Package A = Assembly Location

YY = Year WW = Work Week

ORDERING INFORMATION

| Device | Package | Shipping |
|-----------|---------------------|-----------------|
| NJL3281D | TO-264 | 25 Units / Rail |
| NJL3281DG | TO-264 (Pb-Free) | 25 Units / Rail |
| NJL1302D | TO-264 | 25 Units / Rail |
| NJL1302DG | TO-264 (Pb-Free) | 25 Units / Rail |

^{*}For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MAXIMUM RATINGS ($T_J = 25^{\circ}C$ unless otherwise noted)

| Rating | Symbol | Value | Unit |
|--|-----------------------------------|--------------|-----------|
| Collector–Emitter Voltage | V _{CEO} | 260 | Vdc |
| Collector-Base Voltage | V _{CBO} | 260 | Vdc |
| Emitter-Base Voltage | V _{EBO} | 5 | Vdc |
| Collector–Emitter Voltage – 1.5 V | V _{CEX} | 260 | Vdc |
| Collector Current – Continuous – Peak (Note 1) | I _C | 15 25 | Adc |
| Base Current – Continuous | Ι _Β | 1.5 | Adc |
| Total Power Dissipation @ T _C = 25°C Derate Above 25°C | P _D | 200 1.43 | W W/°C |
| Operating and Storage Junction Temperature Range | T _J , T _{stg} | - 65 to +150 | °C |
| DC Blocking Voltage | V _R | 200 | V |
| Average Rectified Forward Current | I _{F(AV)} | 1.0 | Α |

THERMAL CHARACTERISTICS

| Characteristic | Symbol | Max | Unit |
|--------------------------------------|----------------|-------|------|
| Thermal Resistance, Junction-to-Case | $R_{	heta JC}$ | 0.625 | °C/W |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

ATTRIBUTES

| Cha | racteristic | Value |
|---------------------|-----------------------------------|----------------------|
| ESD Protection | Human Body Model Machine Model | |
| Flammability Rating | | UL 94 V-0 @ 0.125 in |

^{1.} Pulse Test: Pulse Width = 5 ms, Duty Cycle < 10%.

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

| Characteristic | Symbol | Min | Max | Unit |
|--|-----------------------|----------------------------------|---------------------------------|------|
| OFF CHARACTERISTICS | • | • | | • |
| Collector–Emitter Sustaining Voltage $(I_C = 100 \text{ mAdc}, I_B = 0)$ | V _{CEO(sus)} | 260 | _ | Vdc |
| Collector Cutoff Current (V _{CB} = 260 Vdc, I _E = 0) | Ісво | _ | 50 | μAdc |
| Emitter Cutoff Current (V _{EB} = 5 Vdc, I _C = 0) | I _{EBO} | _ | 5 | μAdc |
| ON CHARACTERISTICS | | | | |
| DC Current Gain $ \begin{array}{l} (I_C = 500 \text{ mAdc, } V_{CE} = 5 \text{ Vdc}) \\ (I_C = 1 \text{ Adc, } V_{CE} = 5 \text{ Vdc}) \\ (I_C = 3 \text{ Adc, } V_{CE} = 5 \text{ Vdc}) \\ (I_C = 3 \text{ Adc, } V_{CE} = 5 \text{ Vdc}) \\ (I_C = 5 \text{ Adc, } V_{CE} = 5 \text{ Vdc}) \\ (I_C = 8 \text{ Adc, } V_{CE} = 5 \text{ Vdc}) \end{array} $ | h _{FE} | 75 75 75 75 75 45 | 150 150 150 150 150 | |
| Collector–Emitter Saturation Voltage (I _C = 10 Adc, I _B = 1 Adc) | V _{CE(sat)} | _ | 3 | Vdc |
| DYNAMIC CHARACTERISTICS | | | | |
| Current-Gain - Bandwidth Product (I _C = 1 Adc, V _{CE} = 5 Vdc, f _{test} = 1 MHz) | f⊤ | 30 | _ | MHz |
| Output Capacitance (V _{CB} = 10 Vdc, I _E = 0, f _{test} = 1 MHz) | C _{ob} | _ | 600 | pF |
| Maximum Instantaneous Forward Voltage (Note 2) ($i_F = 1.0 \text{ A}, T_J = 25^{\circ}\text{C}$) ($i_F = 1.0 \text{ A}, T_J = 150^{\circ}\text{C}$) | V _F | 1.1 0.93 | | V |
| Maximum Instantaneous Reverse Current (Note 2) (Rated dc Voltage, $T_J = 25^{\circ}C$) (Rated dc Voltage, $T_J = 150^{\circ}C$) | i _R | 10 100 | | μΑ |
| Maximum Reverse Recovery Time (i _F = 1.0 A, di/dt = 50 A/μs) | t _{rr} | 10 | 00 | ns |

^{2.} Diode Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%.

TYPICAL CHARACTERISTICS

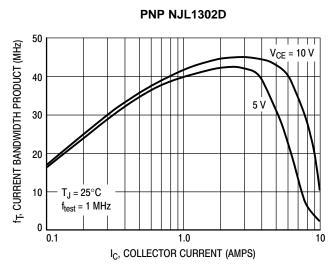


Figure 1. Typical Current Gain Bandwidth Product

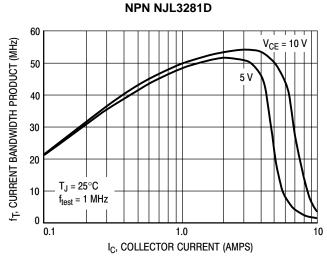


Figure 2. Typical Current Gain Bandwidth Product

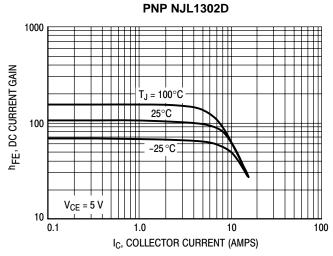


Figure 3. DC Current Gain, V_{CE} = 5 V

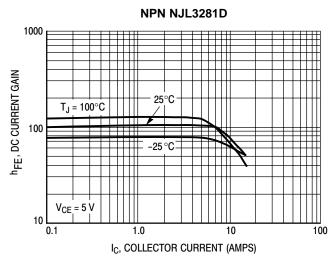


Figure 4. DC Current Gain, V_{CE} = 5 V

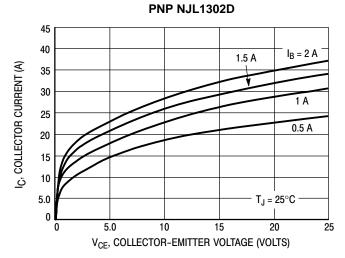


Figure 5. Typical Output Characteristics

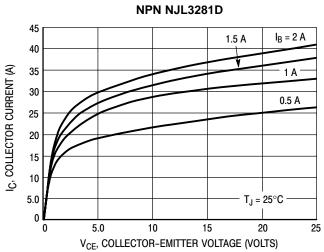


Figure 6. Typical Output Characteristics

TYPICAL CHARACTERISTICS

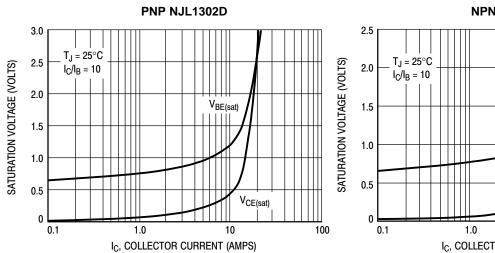


Figure 7. Typical Saturation Voltages

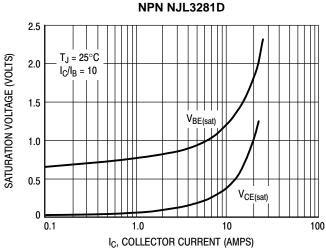


Figure 8. Typical Saturation Voltages

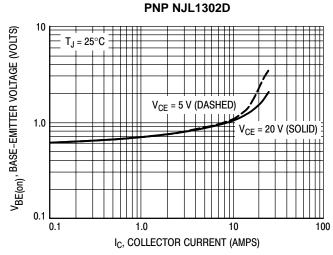


Figure 9. Typical Base-Emitter Voltage

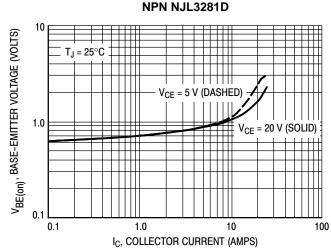


Figure 10. Typical Base-Emitter Voltage

TYPICAL CHARACTERISTICS

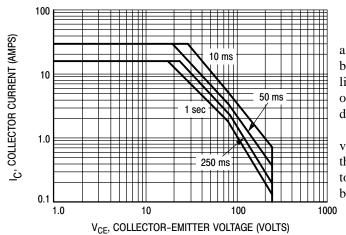


Figure 11. Active Region Safe Operating Area

There are two limitations on the power handling ability of a transistor; average junction temperature and secondary breakdown. Safe operating area curves indicate $I_C - V_{CE}$ limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate.

The data of Figure 11 is based on $T_{J(pk)} = 150$ °C; T_{C} is variable depending on conditions. At high case temperatures, thermal limitations will reduce the power than can be handled to values less than the limitations imposed by second breakdown.

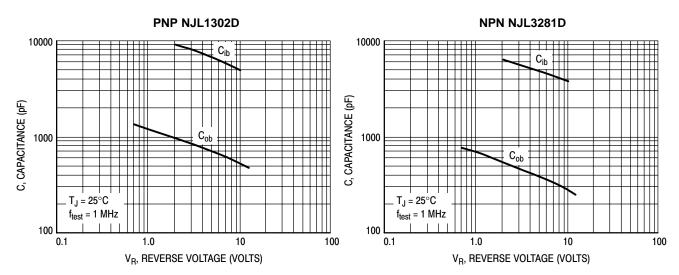


Figure 12. NJL1302D Typical Capacitance

Figure 13. NJL3281D Typical Capacitance

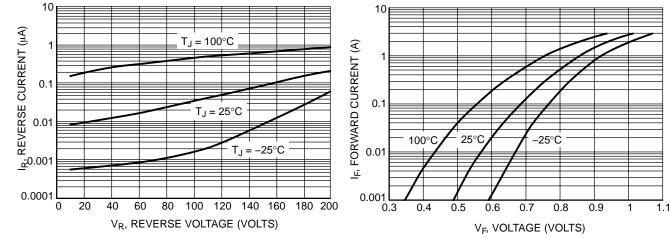


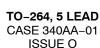
Figure 14. Typical Reverse Current

ThermalTrak is a trademark of Semiconductor Components Industries, LLC (SCILLC).

Figure 15. Typical Forward Voltage



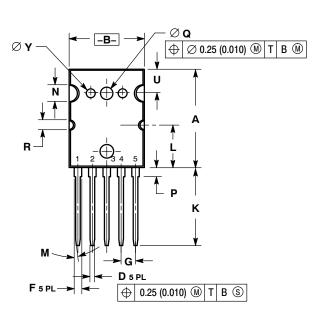


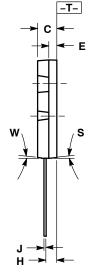


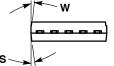
DATE 03 FEB 2005



SCALE 1:2







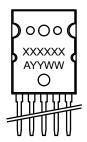
STYLE 1: PIN 1. BASE 2. EMITTER 3. COLLECTOR 4. ANODE

5. CATHODE

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER
- ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: MILLIMETER.

| | MILLIMETERS | | | | INCHES | ; |
|-----|-------------|-----------|------------|-----------|---------|--------|
| DIM | MIN | NOM | MAX | MIN | NOM | MAX |
| Α | 25.857 | 25.984 | 26.111 | 1.018 | 1.023 | 1.028 |
| В | 19.761 | 19.888 | 20.015 | 0.778 | 0.783 | 0.788 |
| С | 4.699 | 4.890 | 5.182 | 0.185 | 0.199 | 0.204 |
| D | 1. | 219 BS | С | 0. | 0480 BS | SC |
| Е | 1.890 | 2.042 | 2.184 | 0.0748 | 0.0804 | 0.0860 |
| F | 1. | 981 BS | С | 0. | 0780 BS | SC |
| G | 3 | .81 BSC | ; | 0 | .150 BS | O |
| Н | 2.667 | 2.718 | 2.769 | 0.1050 | 0.1070 | 0.1090 |
| J | C | 0.584 BSC | | 0. | 0230 B | SC |
| K | 20.422 | 20.549 | 20.676 | 0.804 | 0.809 | 0.814 |
| L | 1 | 11.28 REF | | C | .444 RE | F |
| M | 0 ° | | 7 ° | 0 ° | | 7 ° |
| N | | 4.57 REF | | 0.180 REF | | EF |
| Р | 2.259 | 2.386 | 2.513 | 0.0889 | 0.0939 | 0.0989 |
| Q | 3.480 BSC | | 0.1370 BSC | | SC | |
| R | | 2.54 REF | | 0.100 REF | | ΕF |
| S | 0 ° | | 8 ° | 0 ° | | 8 ° |
| U | 6.17 REF | | | 0.243 F | EF | |
| W | 0 ° | | 6 ° | 0 ° | | 6 ° |
| Υ | 2.388 BSC | | | 0 | .0940 B | SC |

GENERIC MARKING DIAGRAM*



XXXXXX = Specific Device Code = Assembly Location Α

ΥY = Year WW = Work Week = Pb-Free Package G or ■

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

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|------------------|----------------|--|-------------|--|
| DESCRIPTION: | TO-264, 5 LEAD | | PAGE 1 OF 1 | |

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